

STGD6NC60HD

N-channel 600V - 7A - DPAK Very fast PowerMESH™ IGBT

General features

Туре	V _{CES}	V _{CE(sat)} Max @25°C	I _C @100°C
STGD6NC60HD	600V	<2.5V	7A

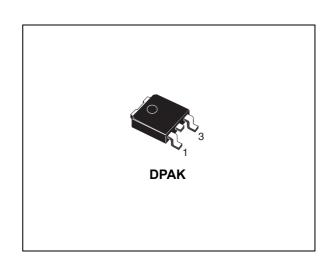
- Low on voltage drop (V_{cesat})
- Low C_{RES} / C_{IES} ratio (no cross-conduction susceptibility)
- Very soft ultra fast recovery antiparallel diode
- High frequency operation



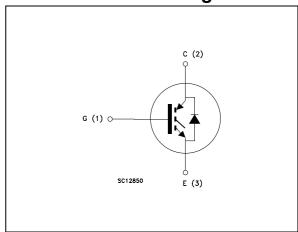
Using the latest high voltage technology based on a patented strip layout, STMicroelectronics has designed an advanced family of IGBTs, the PowerMESHTM IGBTs, with outstanding performances. The suffix "H" identifies a family optimized for high frequency application in order to achieve very high switching performances (reduced tfall) maintaining a low voltage drop.

Applications

- High frequency inverters
- SMPS and PFC in both hard switch and resonant topologies
- Motor drivers



Internal schematic diagram



Order codes

Part number	Marking	Package	Packaging
STGD6NC60HDT4	GD6NC60HD	DPAK	Tape & reel

Contents STGD6NC60HD

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STGD6NC60HD Electrical ratings

1 Electrical ratings

Table 1. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V _{CES}	Collector-emitter voltage (V _{GS} = 0)	600	V
I _C ⁽¹⁾	Collector current (continuous) at T _C = 25°C	15	Α
I _C ⁽¹⁾	Collector current (continuous) at T _C = 100°C	7	Α
I _{CM} ⁽²⁾	Collector current (pulsed)	21	Α
V _{GE}	Gate-emitter voltage	±20	٧
I _F	Diode RMS forward current at Tc=25°C	10	Α
P _{TOT}	Total dissipation at T _C = 25°C	56	W
T _{stg}	Storage temperature		°C
T _j	Operating junction temperature	55 to 150	
T _I	Maximum lead temperature for soldering purpose (for 10sec. 1.6 mm from case)	300	°C

^{1.} Calculated according to the iterative formula:

$$I_{C}(T_{C}) = \frac{T_{JMAX}^{-T}C}{R_{THJ-C}^{\times V}CESAT(MAX)^{(T}C, \ I_{C})}$$

2. Pulse width limited by max junction temperature

Table 2. Thermal resistance

Symbol	Parameter	Value	Unit
Rthj-case	Thermal resistance junction-case max	2	°C/W
Rthj-amb	Thermal resistance junction-ambient max	62.5	°C/W

Electrical characteristics STGD6NC60HD

2 Electrical characteristics

(T_{CASE} =25°C unless otherwise specified)

Table 3. Static

Symbol	Parameter Test conditions		Min.	Тур.	Max.	Unit
V _{BR(CES)}	Collector-emitter breakdown voltage	I _C = 1mA, V _{GE} = 0	600			V
V _{CE(sat)}	Collector-emitter saturation voltage	V_{GE} = 15V, I_{C} = 3A V_{GE} = 15V, I_{C} = 3A, T_{C} = 125°C		1.9 1.7	2.5	V V
V _{GE(th)}	Gate threshold voltage	$V_{CE} = V_{GE}, I_{C} = 250 \mu A$	3.75		5.75	V
I _{CES}	Collector cut-off current (V _{GE} = 0)	V_{CE} = Max rating, T_{C} = 25°C V_{CE} =Max rating, T_{C} = 125°C			10 1	μA mA
I _{GES}	Gate-emitter leakage current (V _{CE} = 0)	V _{GE} = ±20V, V _{CE} = 0			±100	nA
9 _{fs}	Forward transconductance	$V_{CE} = 15V_{,} I_{C} = 3A$		3		S

Table 4. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C _{ies} C _{oes} C _{res}	Input capacitance Output capacitance Reverse transfer capacitance	V _{CE} = 25V, f = 1MHz, V _{GE} = 0		205 32 5.5		pF pF pF
Q _g Q _{ge} Q _{gc}	Total gate charge Gate-emitter charge Gate-collector charge	V_{CE} = 390V, I_{C} = 3A, V_{GE} = 15V, (see Figure 17)		13.6 3.4 5.1		nC nC nC
I _{CL}	Turn-off SOA minimum current	V_{clamp} =390V, Tj=150°C, R _G =10 Ω , V _{GE} =15V		19		Α

Table 5. Switching on/off (inductive load)

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)} t _r (di/dt) _{on}	Turn-on delay time Current rise time Turn-on current slope	V_{CC} = 390V, I_{C} = 3A R_{G} = 10 Ω V_{GE} = 15V, T_{J} = 25°C (see Figure 18)		12 5 612		ns ns A/µs
t _{d(on)} t _r (di/dt) _{on}	Turn-on delay time Current rise time Turn-on current slope	V_{CC} = 390V, I_{C} = 3A R_{G} = 10 Ω V_{GE} = 15V, T_{J} = 125°C (see Figure 18)		13 4.3 560		ns ns A/µs
t _r (V _{off}) t _d (_{off}) t _f	Off voltage rise time Turn-off delay time Current fall time	V_{CC} = 390V, I_{C} = 3A, R_{GE} = 10 Ω , V_{GE} = 15V, T_{J} =25°C (see Figure 18)		40 76 100		ns ns ns
t _r (V _{off}) t _d (_{off}) t _f	Off voltage rise time Turn-off delay time Current fall time	V_{CC} = 390V, I_{C} = 3A, R_{GE} =10 Ω V_{GE} =15V, T_{J} =125°C (see Figure 18)		60 98 124		ns ns ns

Table 6. Switching energy (inductive load)

		-				
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
E _{on} ⁽¹⁾ E _{off} ⁽²⁾ E _{ts}	Turn-on switching losses Turn-off switching losses Total switching losses	V_{CC} = 390V, I_{C} = 3A R_{G} = 10 Ω , V_{GE} = 15V, T_{J} = 25°C (see Figure 18)		20 68 88		μJ μJ μJ
E _{on} ⁽¹⁾ E _{off} ⁽²⁾ E _{ts}	Turn-on switching losses Turn-off switching losses Total switching losses	V_{CC} = 390V, I_{C} = 3A R_{G} = 10 Ω , V_{GE} = 15V, T_{J} = 125°C (see Figure 18)		37 93 130		μJ μJ μJ

Eon is the tun-on losses when a typical diode is used in the test circuit in figure 2. If the IGBT is offered in a package with a co-pak diode, the co-pack diode is used as external diode. IGBTs & Diode are at the same temperature (25°C and 125°C)

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^{2.} Turn-off losses include also the tail of the collector current

Electrical characteristics STGD6NC60HD

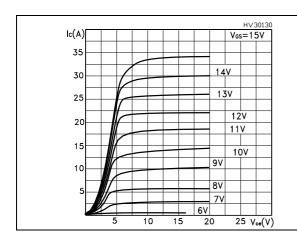
Table 7. Collector-emitter diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _f	Forward on-voltage	$I_f = 1.5A$ $I_f = 1.5A, Tj = 125^{\circ}C$		1.6 1.3	2.1	V V
t _{rr} Q _{rr} I _{rrm}	Reverse recovery time Reverse recovery charge Reverse recovery current	$I_f = 3A, V_R = 40V,$ $Tj = 25^{\circ}C, di/dt = 100 A/\mu s$ (see Figure 19)		21 14 1.36		ns nC A
t _{rr} Q _{rr} I _{rrm}	Reverse recovery time Reverse recovery charge Reverse recovery current	I_f = 3A,V _R = 40V, Tj =125°C, di/dt = 100A/µs (see Figure 19)		34 32 1.88		ns nC A

2.1 Electrical characteristics (curves)

Figure 1. Output characteristics

Figure 2. Transfer characteristics



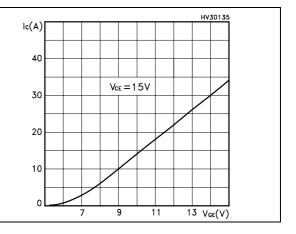
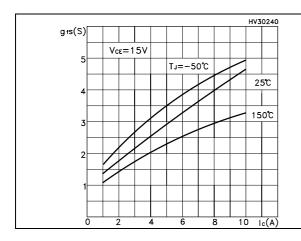


Figure 3. Transconductance

Figure 4. Collector-emitter on voltage vs temperature



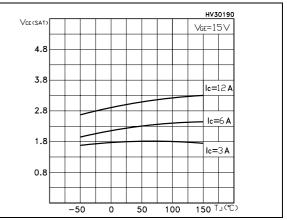
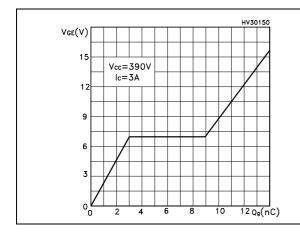
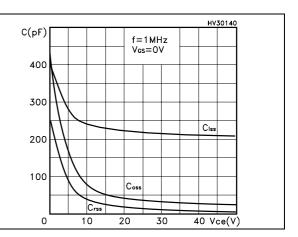


Figure 5. Gate charge vs gate-source voltage Figure 6. Capacitance variations





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Electrical characteristics STGD6NC60HD

Figure 7. Normalized gate threshold voltage Figure 8. Collector-emitter on voltage vs vs temperature collector current

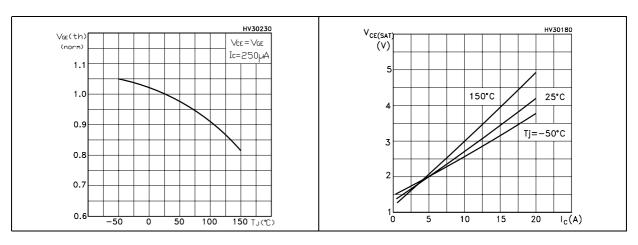


Figure 9. Normalized breakdown voltage vs Figure 10. Switching losses vs temperature temperature

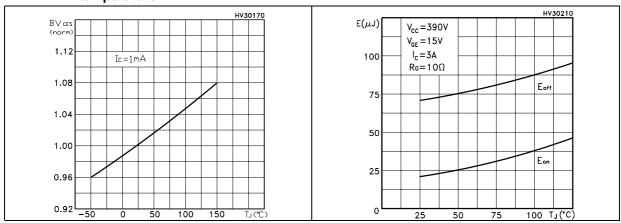
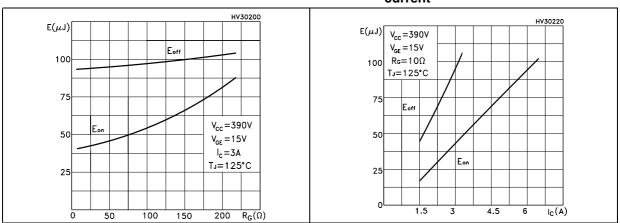


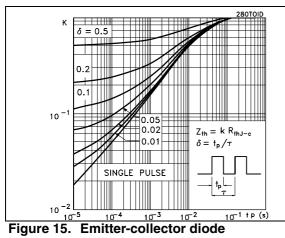
Figure 11. Switching losses vs gate resistance Figure 12. Switching losses vs collector current

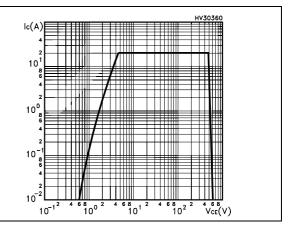


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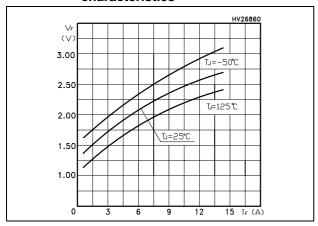
Figure 13. Thermal Impedance

Figure 14. Turn-off SOA





characteristics



Test circuit STGD6NC60HD

3 Test circuit

Figure 16. Test circuit for inductive load switching

Figure 17. Gate charge test circuit

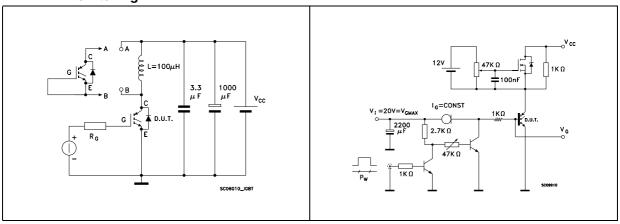
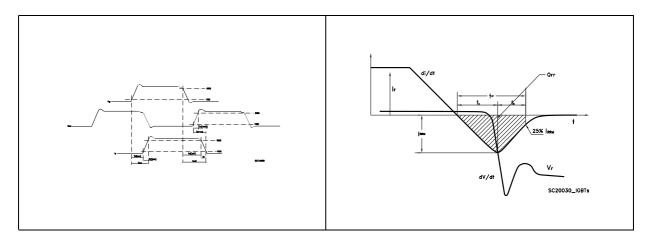


Figure 18. Switching waveform

Figure 19. Diode recovery time waveform



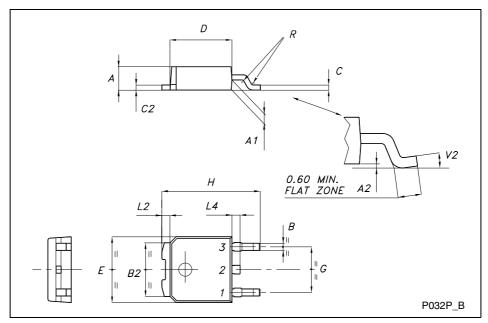
4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com

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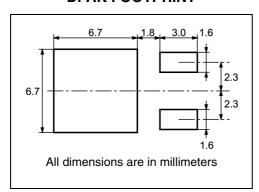
TO-252 (DPAK) MECHANICAL DATA

DIM.		mm			inch	
DIWI.	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
Α	2.20		2.40	0.087		0.094
A1	0.90		1.10	0.035		0.043
A2	0.03		0.23	0.001		0.009
В	0.64		0.90	0.025		0.035
B2	5.20		5.40	0.204		0.213
С	0.45		0.60	0.018		0.024
C2	0.48		0.60	0.019		0.024
D	6.00		6.20	0.236		0.244
E	6.40		6.60	0.252		0.260
G	4.40		4.60	0.173		0.181
Н	9.35		10.10	0.368		0.398
L2		0.8			0.031	
L4	0.60		1.00	0.024		0.039
V2	0°		8°	0°		0°

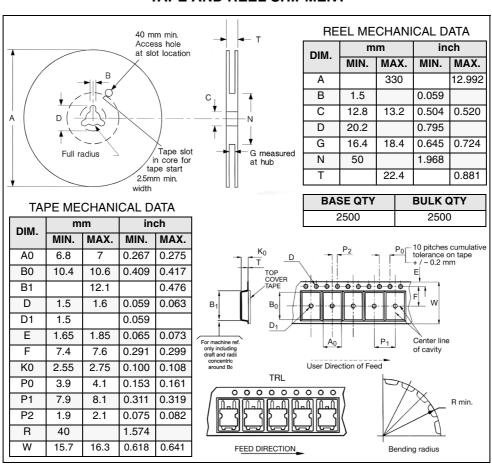


5 Packaging mechanical data

DPAK FOOTPRINT



TAPE AND REEL SHIPMENT



Revision history STGD6NC60HD

6 Revision history

Table 8. Revision history

Date	Revision	Changes
04-Aug-2005	1	First release
07-Mar-2006 2		Complete version
07-Feb-2007	3	The document has been reformatted

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